

COMPACLEAN

HIGH PRESSURE/ HIGH VOLUME CLEANING SYSTEM



APPLICATION

- High capacity & low process cost PCBA cleaning
- Solder pallet cleaning

UNIQUE FEATURES

- Fixed nozzle system
- Basket oscillation
- Uniform covering of cleaned area
- All processes totally separated
- Closed DI water loops available
- 4 step process - each splitted to 5 substeps
- Easy maintenance
- 3 years warranty (on request)

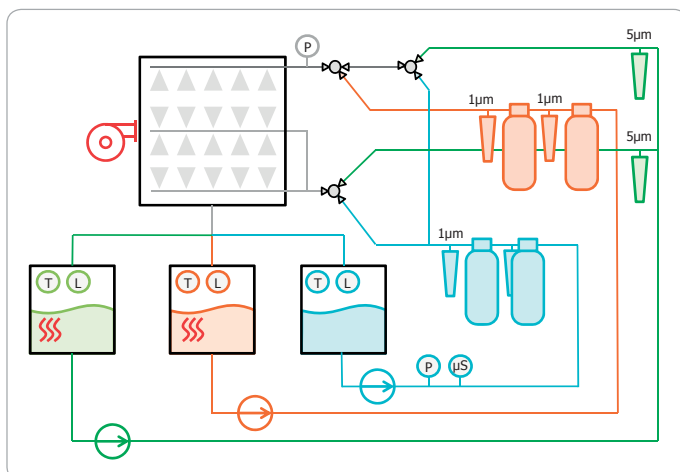
CONTROL SYSTEM

- WIN 7® based, touchscreen, LAN connection
- Complete process traceability available
- Barcode reader for product identification (option)
- Cleaner concentration measuring (option)
- Machine event logging
- Week program for automatic start-up /shut down
- Remote support
- Intuitive control system
- Adaptive rinsing cycle time control
- Three levels password protection

OPTIONAL CONFIGURATION

	Cleaning	1. Rinsing	2. Rinsing	Drying	Recommended use
COMPACLEAN I	Water based	—	—	Hot air	
COMPACLEAN IR (+)	Water based	Tap Water	—	Hot air	
COMPACLEAN II	Water based	—	DI-Water	Hot air	
COMPACLEAN IIR (+)	Water based	Tap Water	DI-Water	Hot air	
COMPACLEAN III	Water based	Pre DI-water	Fine DI-water	Hot air	

PROCESS DIAGRAM



CONTROL TOUCHSCREEN

